ON Semiconductor

Is Now



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Switch-mode Soft Recovery Power Rectifier

These state-of-the-art devices are designed for boost converter or hard-switched converter applications, especially for Power Factor Correction application. It could also be used as a free wheeling diode in variable speed motor control applications and switching mode power supplies.

Features

- Soft Recovery with Low Reverse Recovery Charge (Q_{RR}) and Peak Reverse Recovery Current (I_{RRM})
- Epoxy meets UL 94 V-0 @ 0.125 in
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- These are Pb-Free Devices

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	600	٧
Average Rectified Forward Current (At Rated V_R , T_C = 125°C)	I _O	15	Α
Peak Repetitive Forward Current (At Rated V _R , Square Wave, 20 kHz,T _C = 125°C)	I _{FRM}	30	Α
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I _{FSM}	100	Α
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
MSR1560G: Thermal Resistance Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	1.6 72.8	°C/W
MSRF1560G: Thermal Resistance Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	4.25 75	°C/W

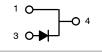
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

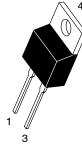


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SOFT RECOVERY POWER RECTIFIER 15 AMPERES, 600 VOLTS



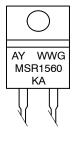


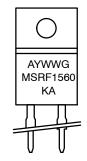


3 TO-220AC CASE 221B STYLE 1

TO-220 FULLPAK CASE 221AG STYLE 1

MARKING DIAGRAMS





A = Assembly Location

Y = Year
WW = Work Week
G = Pb-Free Package
KA = Diode Polarity

ORDERING INFORMATION

Device	Package	Shipping	
MSR1560G	TO-220AC (Pb-Free)	50 Units/Rail	
MSRF1560G	TO-220FP (Pb-Free)	50 Units/Rail	

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Va	lue	Unit
Instantaneous Forward Voltage (Note 1) (I _F = 15 A)	V _F	T _J = 25°C	T _J = 150°C	V
Maximum Typical		1.8 1.5	1.4 1.2	
Instantaneous Reverse Current (V _R = 600 V)	I _R	T _J = 25°C	T _J = 150°C	μΑ
Maximum Typical		15 0.4	5000 100	
Reverse Recovery Time (Note 2) ($V_R = 30 \text{ V}$, $I_F = 1 \text{ A}$, $di/dt = 100 \text{ A}/\mu\text{s}$)	t _{rr}	T _J = 25°C	T _J = 100°C	ns
Maximum Typical		45 35	65 54	
Typical Recovery Softness Factor (V _R = 30 V, I _F = 1 A, di/dt = 100 A/μs)	s = t _b /t _a	0.67	0.74	
Typical Peak Reverse Recovery Current (V _R = 30 V, I _F = 1 A, di/dt = 100 A/μs)	I _{RRM}	2.3	3.2	Α
Typical Reverse Recovery Charge (V _R = 30 V, I _F = 1 A, di/dt = 100 A/μs)	Q _{RR}	31	78	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pulse Test: Pulse Width \leq 380 μ s, Duty Cycle \leq 2%

- 2. T_{RR} measured projecting from 25% of I_{RRM} to zero current

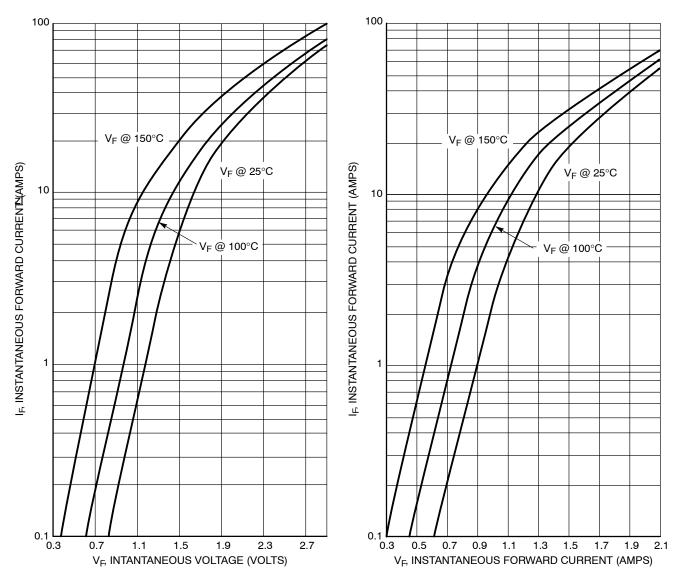


Figure 1. Maximum Forward Voltage

Figure 2. Typical Forward Voltage

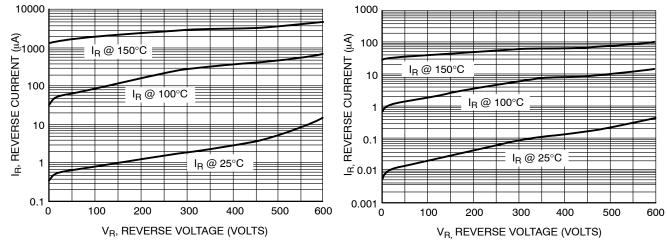


Figure 3. Maximum Reverse Current

Figure 4. Typical Reverse Current

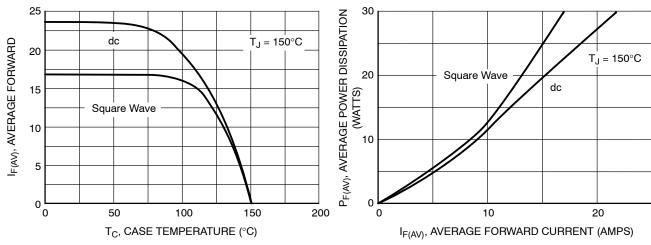


Figure 5. Current Derating

Figure 6. Power Dissipation

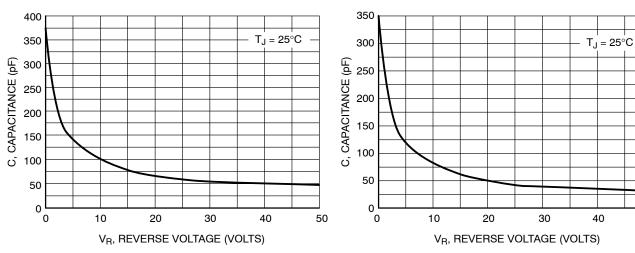


Figure 7. Maximum Capacitance

Figure 8. Typical Capacitance

50

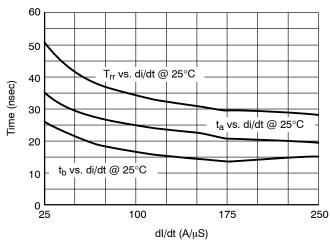


Figure 9. Typical Trr vs. di/dt

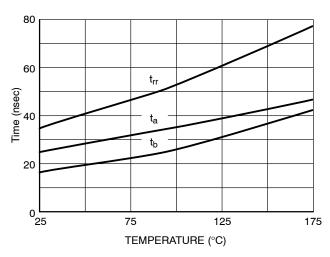


Figure 10. Typical Trr vs. Temperature

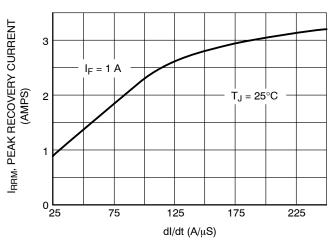


Figure 11. Typical Peak Reverse Recovery Current

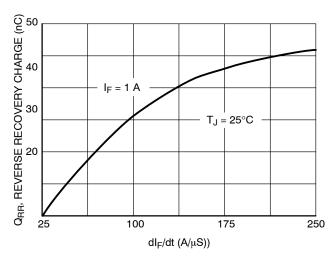


Figure 12. Typical Reverse Recovery Charge

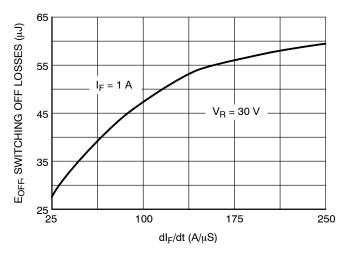


Figure 13. Typical Switching Off Losses

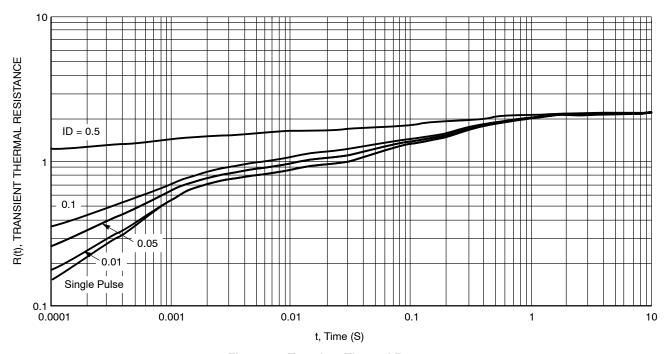


Figure 14. Transient Thermal Response

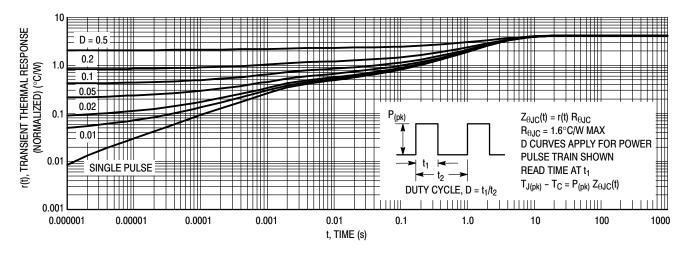


Figure 15. Thermal Response, (MSRF1560) Junction-to-Case ($R_{\theta JC}$)

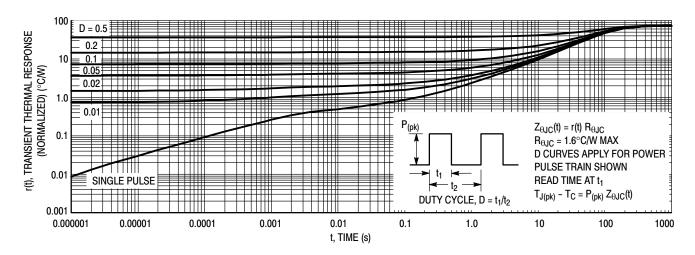
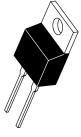


Figure 16. Thermal Response, (MSRF1560) Junction–to–Ambient ($R_{\theta JA}$)

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





TO-220, 2-LEAD CASE 221B-04 ISSUE F

DATE 12 APR 2013

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.595	0.620	15.11	15.75
В	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.82
D	0.025	0.039	0.64	1.00
F	0.142	0.161	3.61	4.09
G	0.190	0.210	4.83	5.33
Н	0.110	0.130	2.79	3.30
L	0.014	0.025	0.36	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
Ø	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.14	1.39
Т	0.235	0.255	5.97	6.48
U	0.000	0.050	0.000	1.27

Q SCALE 1:1

STYLE 1: PIN 1. CATHODE 2. N/A 3. ANODE

PIN 1. ANODE 2. N/A 3. CATHODE 4. ANODE

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